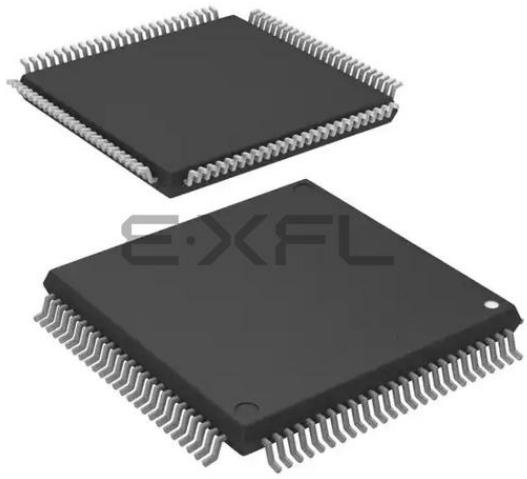
Renesas Electronics America Inc - R5F64168DFB#U0 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Last Time Buy
Core Processor	R32C/100
Core Size	16/32-Bit
Speed	50MHz
Connectivity	EBI/EMI, I²C, IEBus, UART/USART
Peripherals	DMA, LVD, PWM, WDT
Number of I/O	84
Program Memory Size	768KB (768K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	63K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f64168dfb-u0

1.1.2 Performance Overview

Tables 1.1 to 1.4 list the performance overview of the R32C/116 Group.

Table 1.1 Performance Overview for the 144-pin Package (1/2)

Unit	Function	Explanation
CPU	Central processing unit	R32C/100 Series CPU Core • Basic instructions: 108 • Minimum instruction execution time: 15.625 ns (f(CPU) = 64 MHz) • Multiplier: 32-bit × 32-bit → 64-bit • Multiply-accumulate unit: 32-bit × 32-bit + 64-bit → 64-bit • IEEE-754 compatible FPU: Single precision • 32-bit barrel shifter • Operating mode: Single-chip mode, memory expansion mode, microprocessor mode (optional (1))
Memory		Flash memory: 384 Kbytes to 1 Mbyte RAM: 40 K/48 K/63 Kbytes Data flash: 4 Kbytes × 2 blocks Refer to Table 1.5 for each product's memory size
Voltage Detector	Low voltage detector	Optional (1) Low voltage detection interrupt
Clock	Clock generator	• 4 circuits (main clock, sub clock, PLL, on-chip oscillator) • Oscillation stop detector: Main clock oscillator stop/restart detection • Frequency divide circuit: Divide-by-2 to divide-by-24 selectable • Low power modes: Wait mode, stop mode
External Bus Expansion	Bus and memory expansion	• Address space: 4 Gbytes (of which up to 64 Mbytes is user accessible) • External bus Interface: Support for wait-state insertion, 4 chip select outputs • Bus format: Separate bus/Multiplexed bus selectable, data bus width selectable (8/16/32 bits)
Interrupts		Interrupt vectors: 261 External interrupt inputs: $\overline{\text{NMI}}$, $\overline{\text{INT}}$ × 9, key input × 4 Interrupt priority levels: 7
Watchdog Timer		15 bits × 1 (selectable input frequency from prescaler output)
DMA	DMAC	4 channels • Cycle-steal transfer mode • Request sources: 57 • 2 transfer modes: Single transfer, repeat transfer
	DMAC II	• Triggered by an interrupt request of any peripheral • 3 characteristic transfer functions: Immediate data transfer, calculation result transfer, chain transfer
I/O Ports	Programmable I/O ports	• 2 input-only ports • 120 CMOS I/O ports (of which 32 are 5 V tolerant) • A pull-up resistor is selectable for every 4 input ports (except 5 V tolerant inputs)

Note:
1. Contact a Renesas Electronics sales office to use the optional features.

Table 1.7 Pin Characteristics for the 144-pin Package (1/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
1		P9_6			TXD4/SDA4/SRXD4		ANEX1	
2		P9_5			CLK4		ANEX0	
3		P9_4		TB4IN	$\overline{CTS4}$/$\overline{RTS4}$/$\overline{SS4}$		DA1	
4		P9_3		TB3IN	$\overline{CTS3}$/$\overline{RTS3}$/$\overline{SS3}$		DA0	
5		P9_2		TB2IN	TXD3/SDA3/SRXD3	OUTC2_0/ISTXD2/ IEOUT		
6		P9_1		TB1IN	RXD3/SCL3/STXD3	ISRXD2/IEIN		
7		P9_0		TB0IN	CLK3			
8		P14_6	$\overline{INT8}$					
9		P14_5	$\overline{INT7}$					
10		P14_4	$\overline{INT6}$					
11		P14_3						
12	VDC0							
13		P14_1						
14	VDC1							
15	NSD							
16	CNVSS							
17	XCIN	P8_7						
18	XCOUT	P8_6						
19	$\overline{RESET}$							
20	XOUT							
21	VSS							
22	XIN							
23	VCC							
24		P8_5	$\overline{NMI}$					
25		P8_4	$\overline{INT2}$					
26		P8_3	$\overline{INT1}$					
27		P8_2	$\overline{INT0}$					
28		P8_1		TA4IN/$\overline{U}$	$\overline{CTS5}$/$\overline{RTS5}$/$\overline{SS5}$	IIO1_5/UD0B/UD1B		
29		P8_0		TA4OUT/U	RXD5/SCL5/STXD5	UD0A/UD1A		
30		P7_7		TA3IN	CLK5	IIO1_4/UD0B/UD1B		
31		P7_6		TA3OUT	TXD5/SDA5/SRXD5/ $\overline{CTS8}$/$\overline{RTS8}$	IIO1_3/UD0A/UD1A		
32		P7_5		TA2IN/$\overline{W}$	RXD8	IIO1_2		
33		P7_4		TA2OUT/W	CLK8	IIO1_1		
34		P7_3		TA1IN/$\overline{V}$	$\overline{CTS2}$/$\overline{RTS2}$/$\overline{SS2}$/TXD8	IIO1_0		
35		P7_2		TA1OUT/V	CLK2			
36		P7_1		TA0IN/ TB5IN	RXD2/SCL2/STXD2/ MSCL	IIO1_7/OUTC2_2/ ISRXD2/IEIN		

Table 1.8 Pin Characteristics for the 144-pin Package (2/4)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
37		P7_0		TA0OUT	TXD2/SDA2/SRXD2/ MSDA	IIO1_6/OUTC2_0/ ISTXD2/IEOUT		
38		P6_7			TXD1/SDA1/SRXD1			
39	VCC							
40		P6_6			RXD1/SCL1/STXD1			
41	VSS							
42		P6_5			CLK1			
43		P6_4			$\overline{\text{CTS1}}/\overline{\text{RTS1}}/\overline{\text{SS1}}$	OUTC2_1/ISCLK2		
44		P6_3			TXD0/SDA0/SRXD0			
45		P6_2		TB2IN	RXD0/SCL0/STXD0			
46		P6_1		TB1IN	CLK0			
47		P6_0		TB0IN	$\overline{\text{CTS0}}/\overline{\text{RTS0}}/\overline{\text{SS0}}$			
48		P13_7				OUTC2_7		D31
49		P13_6				OUTC2_1/ISCLK2		D30
50		P13_5				OUTC2_2/ISRXD2/ IEIN		D29
51		P13_4				OUTC2_0/ISTXD2/ IEOUT		D28
52		P5_7			$\overline{\text{CTS7}}/\overline{\text{RTS7}}$			$\overline{\text{RDY}}/\overline{\text{CS3}}$
53		P5_6			RXD7			ALE/$\overline{\text{CS2}}$
54		P5_5			CLK7			$\overline{\text{HOLD}}$
55		P5_4			TXD7			$\overline{\text{HLDA}}/\overline{\text{CS1}}$
56		P13_3				OUTC2_3		D27
57	VSS							
58		P13_2				OUTC2_6		D26
59	VCC							
60		P13_1				OUTC2_5		D25
61		P13_0				OUTC2_4		D24
62		P5_3						CLKOUT/ BCLK
63		P5_2						$\overline{\text{RD}}$
64		P5_1						$\overline{\text{WR1}}/\overline{\text{BC1}}$
65		P5_0						$\overline{\text{WR0}}/\overline{\text{WR}}$
66		P12_7						D23
67		P12_6						D22
68		P12_5						D21
69		P4_7			TXD6/SDA6/SRXD6			$\overline{\text{CS0}}$/A23
70		P4_6			RXD6/SCL6/STXD6			$\overline{\text{CS1}}$/A22
71		P4_5			CLK6			$\overline{\text{CS2}}$/A21
72		P4_4			$\overline{\text{CTS6}}/\overline{\text{RTS6}}/\overline{\text{SS6}}$			$\overline{\text{CS3}}$/A20
73		P4_3			TXD3/SDA3/SRXD3	OUTC2_0/ISTXD2/ IEOUT		A19
74	VCC							

Table 1.15 Pin Definitions and Functions (2/4)

Function	Symbol	I/O	Description
Bus control pins	$\overline{BC0}$/D0, $\overline{BC2}$/D1 (1)	I/O	Output of byte control ($\overline{BC0}$ and $\overline{BC2}$) and input/output of data (D0 and D1) by time-division while accessing an external memory space with multiplexed bus
	$\overline{CS0}$ to $\overline{CS3}$	O	Chip select output
	$\overline{WR0}$/$\overline{WR1}$/$\overline{WR2}$/$\overline{WR3}$, $\overline{WR}$/$\overline{BC0}$/$\overline{BC1}$/$\overline{BC2}$/$\overline{BC3}$, $\overline{RD}$ (1)	O	Output of write, byte control, and read signals. Either $\overline{WRx}$ or $\overline{WR}$ and $\overline{BCx}$ can be selected by a program. Data is read when $\overline{RD}$ is low. • When $\overline{WR0}$, $\overline{WR1}$, $\overline{WR2}$, $\overline{WR3}$, and $\overline{RD}$ are selected, data is written to the following address: 4n+0, when $\overline{WR0}$ is low 4n+1, when $\overline{WR1}$ is low 4n+2, when $\overline{WR2}$ is low 4n+3, when $\overline{WR3}$ is low on 32-bit external data bus or an even address, when $\overline{WR0}$ is low an odd address, when $\overline{WR1}$ is low on 16-bit external data bus • When $\overline{WR}$, $\overline{BC0}$, $\overline{BC1}$, $\overline{BC2}$, $\overline{BC3}$, and $\overline{RD}$ are selected, data is written, when $\overline{WR}$ is low and the following address is accessed: 4n+0, when $\overline{BC0}$ is low 4n+1, when $\overline{BC1}$ is low 4n+2, when $\overline{BC2}$ is low 4n+3, when $\overline{BC3}$ is low on 32-bit external data bus or an even address, when $\overline{BC0}$ is low an odd address, when $\overline{BC1}$ is low on 16-bit external data bus
	ALE	O	Latch enable signal in multiplexed bus format
	$\overline{HOLD}$	I	The MCU is in a hold state while this pin is held low
	$\overline{HLDA}$	O	This pin is driven low while the MCU is held in a hold state
	$\overline{RDY}$	I	Bus cycle is extended by the CPU if this pin is low on the falling edge of BCLK

Note:
1. Pins $\overline{BC2}$/D1, $\overline{WR2}$, $\overline{WR3}$, $\overline{BC2}$, and $\overline{BC3}$ are available in the 144-pin package only.

Table 1.17 Pin Definitions and Functions (4/4)

Function	Symbol	I/O	Description
A/D converter	AN_0 to AN_7, AN0_0 to AN0_7, AN2_0 to AN2_7, AN15_0 to AN15_7 (1)	I	Analog input for the A/D converter
	$\overline{\text{ADTRG}}$	I	External trigger input for the A/D converter
	ANEX0	I/O	Expanded analog input for the A/D converter and output in external op-amp connection mode
	ANEX1	I	Expanded analog input for the A/D converter
D/A converter	DA0, DA1	O	Output for the D/A converter
Reference voltage input	VREF	I	Reference voltage input for the A/D converter and D/A converter
Intelligent I/O	IIO0_0 to IIO0_7	I/O	Input/output for Intelligent I/O group 0. Either input capture or output compare is selectable
	IIO1_0 to IIO1_7	I/O	Input/output for Intelligent I/O group 1. Either input capture or output compare is selectable
	UD0A, UD0B, UD1A, UD1B	I	Input for the two-phase encoder
	OUTC2_0 to OUTC2_7 (2)	O	Output for OC (output compare) of Intelligent I/O group 2
	ISCLK2	I/O	Clock input/output for the serial interface
	ISRXD2	I	Receive data input for the serial interface
	ISTXD2	O	Transmit data output for the serial interface
	IEIN	I	Receive data input for the serial interface
	IEOUT	O	Transmit data output for the serial interface
Multi-master I^2C-bus	MSDA	I/O	Serial data input/output
	MSCL	I/O	Transmit/receive clock input/output

Notes:
1. Pins AN15_0 to AN15_7 are available in the 144-pin package only.
2. Pins OUTC2_3 to OUTC2_7 are available in the 144-pin package only.

Table 4.2 SFR List (2)

Address	Register	Symbol	Reset Value
000060h			
000061h	Timer B5 Interrupt Control Register	TB5IC	XXXX X000b
000062h	UART5 Transmit/NACK Interrupt Control Register	S5TIC	XXXX X000b
000063h	UART2 Receive/ACK Interrupt Control Register/I2C-bus Line Interrupt Control Register	S2RIC/I2CLIC	XXXX X000b
000064h	UART6 Transmit/NACK Interrupt Control Register	S6TIC	XXXX X000b
000065h	UART3 Receive/ACK Interrupt Control Register	S3RIC	XXXX X000b
000066h	UART5/6 Bus Collision, START Condition/STOP Condition Detection Interrupt Control Register	BCN5IC/BCN6IC	XXXX X000b
000067h	UART4 Receive/ACK Interrupt Control Register	S4RIC	XXXX X000b
000068h	DMA0 Transfer Complete Interrupt Control Register	DM0IC	XXXX X000b
000069h	UART0/3 Bus Collision, START Condition/STOP Condition Detection Interrupt Control Register	BCN0IC/BCN3IC	XXXX X000b
00006Ah	DMA2 Transfer Complete Interrupt Control Register	DM2IC	XXXX X000b
00006Bh	A/D Converter 0 Convert Completion Interrupt Control Register	AD0IC	XXXX X000b
00006Ch	Timer A0 Interrupt Control Register	TA0IC	XXXX X000b
00006Dh	Intelligent I/O Interrupt Control Register 0	IIO0IC	XXXX X000b
00006Eh	Timer A2 Interrupt Control Register	TA2IC	XXXX X000b
00006Fh	Intelligent I/O Interrupt Control Register 2	IIO2IC	XXXX X000b
000070h	Timer A4 Interrupt Control Register	TA4IC	XXXX X000b
000071h	Intelligent I/O Interrupt Control Register 4	IIO4IC	XXXX X000b
000072h	UART0 Receive/ACK Interrupt Control Register	S0RIC	XXXX X000b
000073h	Intelligent I/O Interrupt Control Register 6	IIO6IC	XXXX X000b
000074h	UART1 Receive/ACK Interrupt Control Register	S1RIC	XXXX X000b
000075h	Intelligent I/O Interrupt Control Register 8	IIO8IC	XXXX X000b
000076h	Timer B1 Interrupt Control Register	TB1IC	XXXX X000b
000077h	Intelligent I/O Interrupt Control Register 10	IIO10IC	XXXX X000b
000078h	Timer B3 Interrupt Control Register	TB3IC	XXXX X000b
000079h			
00007Ah	INT5 Interrupt Control Register	INT5IC	XX00 X000b
00007Bh			
00007Ch	INT3 Interrupt Control Register	INT3IC	XX00 X000b
00007Dh			
00007Eh	INT1 Interrupt Control Register	INT1IC	XX00 X000b
00007Fh			
000080h			
000081h	UART2 Transmit/NACK Interrupt Control Register/I2C-bus Interrupt Control Register	S2TIC/I2CIC	XXXX X000b
000082h	UART5 Receive/ACK Interrupt Control Register	S5RIC	XXXX X000b
000083h	UART3 Transmit/NACK Interrupt Control Register	S3TIC	XXXX X000b
000084h	UART6 Receive/ACK Interrupt Control Register	S6RIC	XXXX X000b
000085h	UART4 Transmit/NACK Interrupt Control Register	S4TIC	XXXX X000b
000086h			
000087h	UART2 Bus Collision, START Condition/STOP Condition Detection Interrupt Control Register	BCN2IC	XXXX X000b

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.4 SFR List (4)

Address	Register	Symbol	Reset Value
0000B0h	Intelligent I/O Interrupt Enable Register 0	IIO0IE	00h
0000B1h	Intelligent I/O Interrupt Enable Register 1	IIO1IE	00h
0000B2h	Intelligent I/O Interrupt Enable Register 2	IIO2IE	00h
0000B3h	Intelligent I/O Interrupt Enable Register 3	IIO3IE	00h
0000B4h	Intelligent I/O Interrupt Enable Register 4	IIO4IE	00h
0000B5h	Intelligent I/O Interrupt Enable Register 5	IIO5IE	00h
0000B6h	Intelligent I/O Interrupt Enable Register 6	IIO6IE	00h
0000B7h	Intelligent I/O Interrupt Enable Register 7	IIO7IE	00h
0000B8h	Intelligent I/O Interrupt Enable Register 8	IIO8IE	00h
0000B9h	Intelligent I/O Interrupt Enable Register 9	IIO9IE	00h
0000BAh	Intelligent I/O Interrupt Enable Register 10	IIO10IE	00h
0000BBh	Intelligent I/O Interrupt Enable Register 11	IIO11IE	00h
0000BCh			
0000BDh			
0000BEh			
0000BFh			
0000C0h			
0000C1h			
0000C2h			
0000C3h			
0000C4h			
0000C5h			
0000C6h			
0000C7h			
0000C8h			
0000C9h			
0000CAh			
0000CBh			
0000CCh			
0000CDh			
0000CEh			
0000CFh			
0000D0h			
0000D1h			
0000D2h			
0000D3h			
0000D4h			
0000D5h			
0000D6h			
0000D7h			
0000D8h			
0000D9h			
0000DAh			
0000DBh			
0000DCh			
0000DDh	UART7 Transmit Interrupt Control Register	S7TIC	XXXX X000b
0000DEh	INT7 Interrupt Control Register	INT7IC	XX00 X000b
0000DFh	UART8 Transmit Interrupt Control Register	S8TIC	XXXX X000b

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.8 SFR List (8)

Address	Register	Symbol	Reset Value
000170h	Group 2 IEBus Address Register	IEAR	XXXXh
000171h			
000172h	Group 2 IEBus Control Register	IECR	00XX X000b
000173h	Group 2 IEBus Transmit Interrupt Source Detect Register	IETIF	XXX0 0000b
000174h	Group 2 IEBus Receive Interrupt Source Detect Register	IERIF	XXX0 0000b
000175h			
000176h			
000177h			
000178h			
000179h			
00017Ah			
00017Bh			
00017Ch			
00017Dh			
00017Eh			
00017Fh			
000180h	Group 0 Time Measurement/Waveform Generation Register 0	G0TM0/G0PO0	XXXXh
000181h			
000182h	Group 0 Time Measurement/Waveform Generation Register 1	G0TM1/G0PO1	XXXXh
000183h			
000184h	Group 0 Time Measurement/Waveform Generation Register 2	G0TM2/G0PO2	XXXXh
000185h			
000186h	Group 0 Time Measurement/Waveform Generation Register 3	G0TM3/G0PO3	XXXXh
000187h			
000188h	Group 0 Time Measurement/Waveform Generation Register 4	G0TM4/G0PO4	XXXXh
000189h			
00018Ah	Group 0 Time Measurement/Waveform Generation Register 5	G0TM5/G0PO5	XXXXh
00018Bh			
00018Ch	Group 0 Time Measurement/Waveform Generation Register 6	G0TM6/G0PO6	XXXXh
00018Dh			
00018Eh	Group 0 Time Measurement/Waveform Generation Register 7	G0TM7/G0PO7	XXXXh
00018Fh			
000190h	Group 0 Waveform Generation Control Register 0	G0POCR0	0000 X000b
000191h	Group 0 Waveform Generation Control Register 1	G0POCR1	0X00 X000b
000192h	Group 0 Waveform Generation Control Register 2	G0POCR2	0X00 X000b
000193h	Group 0 Waveform Generation Control Register 3	G0POCR3	0X00 X000b
000194h	Group 0 Waveform Generation Control Register 4	G0POCR4	0X00 X000b
000195h	Group 0 Waveform Generation Control Register 5	G0POCR5	0X00 X000b
000196h	Group 0 Waveform Generation Control Register 6	G0POCR6	0X00 X000b
000197h	Group 0 Waveform Generation Control Register 7	G0POCR7	0X00 X000b
000198h	Group 0 Time Measurement Control Register 0	G0TMCR0	00h
000199h	Group 0 Time Measurement Control Register 1	G0TMCR1	00h
00019Ah	Group 0 Time Measurement Control Register 2	G0TMCR2	00h
00019Bh	Group 0 Time Measurement Control Register 3	G0TMCR3	00h
00019Ch	Group 0 Time Measurement Control Register 4	G0TMCR4	00h
00019Dh	Group 0 Time Measurement Control Register 5	G0TMCR5	00h
00019Eh	Group 0 Time Measurement Control Register 6	G0TMCR6	00h
00019Fh	Group 0 Time Measurement Control Register 7	G0TMCR7	00h

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.13 SFR List (13)

Address	Register	Symbol	Reset Value
000320h			
000321h			
000322h			
000323h			
000324h	UART3 Special Mode Register 4	U3SMR4	00h
000325h	UART3 Special Mode Register 3	U3SMR3	00h
000326h	UART3 Special Mode Register 2	U3SMR2	00h
000327h	UART3 Special Mode Register	U3SMR	00h
000328h	UART3 Transmit/Receive Mode Register	U3MR	00h
000329h	UART3 Bit Rate Register	U3BRG	XXh
00032Ah	UART3 Transmit Buffer Register	U3TB	XXXXh
00032Bh			
00032Ch	UART3 Transmit/Receive Control Register 0	U3C0	0000 1000b
00032Dh	UART3 Transmit/Receive Control Register 1	U3C1	0000 0010b
00032Eh	UART3 Receive Buffer Register	U3RB	XXXXh
00032Fh			
000330h			
000331h			
000332h			
000333h			
000334h	UART2 Special Mode Register 4	U2SMR4	00h
000335h	UART2 Special Mode Register 3	U2SMR3	00h
000336h	UART2 Special Mode Register 2	U2SMR2	00h
000337h	UART2 Special Mode Register	U2SMR	00h
000338h	UART2 Transmit/Receive Mode Register	U2MR	00h
000339h	UART2 Bit Rate Register	U2BRG	XXh
00033Ah	UART2 Transmit Buffer Register	U2TB	XXXXh
00033Bh			
00033Ch	UART2 Transmit/Receive Control Register 0	U2C0	0000 1000b
00033Dh	UART2 Transmit/Receive Control Register 1	U2C1	0000 0010b
00033Eh	UART2 Receive Buffer Register	U2RB	XXXXh
00033Fh			
000340h	Count Start Register	TABSR	0000 0000b
000341h	Clock Prescaler Reset Register	CPSRF	0XXX XXXXb
000342h	One-shot Start Register	ONSF	0000 0000b
000343h	Trigger Select Register	TRGSR	0000 0000b
000344h	Increment/Decrement Select Register	UDF	0000 0000b
000345h			
000346h	Timer A0 Register	TA0	XXXXh
000347h			
000348h	Timer A1 Register	TA1	XXXXh
000349h			
00034Ah	Timer A2 Register	TA2	XXXXh
00034Bh			
00034Ch	Timer A3 Register	TA3	XXXXh
00034Dh			
00034Eh	Timer A4 Register	TA4	XXXXh
00034Fh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 4.15 SFR List (15)

Address	Register	Symbol	Reset Value
000380h	A/D0 Register 0	AD00	00XXh
000381h			
000382h	A/D0 Register 1	AD01	00XXh
000383h			
000384h	A/D0 Register 2	AD02	00XXh
000385h			
000386h	A/D0 Register 3	AD03	00XXh
000387h			
000388h	A/D0 Register 4	AD04	00XXh
000389h			
00038Ah	A/D0 Register 5	AD05	00XXh
00038Bh			
00038Ch	A/D0 Register 6	AD06	00XXh
00038Dh			
00038Eh	A/D0 Register 7	AD07	00XXh
00038Fh			
000390h			
000391h			
000392h	A/D0 Control Register 4	AD0CON4	XXXX 00XXb
000393h			
000394h	A/D0 Control Register 2	AD0CON2	XX0X X000b
000395h	A/D0 Control Register 3	AD0CON3	XXXX X000b
000396h	A/D0 Control Register 0	AD0CON0	00h
000397h	A/D0 Control Register 1	AD0CON1	00h
000398h	D/A Register 0	DA0	XXh
000399h			
00039Ah	D/A Register 1	DA1	XXh
00039Bh			
00039Ch	D/A Control Register	DACON	XXXX XX00b
00039Dh			
00039Eh			
00039Fh			
0003A0h			
0003A1h			
0003A2h			
0003A3h			
0003A4h			
0003A5h			
0003A6h			
0003A7h			
0003A8h			
0003A9h			
0003AAh			
0003ABh			
0003ACh			
0003ADh			
0003AEh			
0003AFh			

X: Undefined
Blanks are reserved. No access is allowed.

Table 5.7 Electrical Characteristics of RAM
(V_{CC} = 3.0 to 5.5 V, V_{SS} = 0 V, and Ta = T_{opr}, unless otherwise noted)

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
V_{RDR}	RAM data retention voltage	In stop mode	2.0			V

Table 5.8 Electrical Characteristics of Flash Memory
(V_{CC} = 3.0 to 5.5 V, V_{SS} = 0 V, and Ta = T_{opr}, unless otherwise noted)

Symbol	Characteristic		Value			Unit
			Min.	Typ.	Max.	
—	Program/erase cycles (1)	Program area	1000			Cycles
		Data area	10000			Cycles
—	4-word program time	Program area		150	900	µs
		Data area		300	1700	µs
—	Lock bit program time	Program area		70	500	µs
		Data area		140	1000	µs
—	Block erasure time	4-Kbyte block		0.12	3.0	s
		32-Kbyte block		0.17	3.0	s
		64-Kbyte block		0.20	3.0	s
—	Data retention (2)	T_a = 55°C (3)	10			Years

Notes:
1. Program/erase definition
   This value represents the number of erasures per block.
   When the number of program/erase cycles is n, each block can be erased n times.
   For example, if a 4-word write is performed in 512 different addresses in the 4-Kbyte block A and then the block is erased, this is counted as a single program/erase operation.
   However, the same address cannot be written to more than once per erasure (overwrite disabled).
2. Data retention includes periods when no supply voltage is applied and no clock is provided.
3. Contact a Renesas Electronics sales office for data retention times other than the above condition.

V_{CC} = 5 V

Table 5.19 D/A Conversion Characteristics (V_{CC} = AV_{CC} = V_{REF} = 4.2 to 5.5 V, V_{SS} = AV_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Symbol	Characteristic	Measurement Condition	Value			Unit
			Min.	Typ.	Max.	
—	Resolution				8	Bits
—	Absolute precision				1.0	%
t_S	Settling time				3	µs
R_O	Output resistance		4	10	20	kΩ
I_{VREF}	Reference input current	See Note 1			1.5	mA

Note:
1. One D/A converter is used. The DAi register (i = 0, 1) of the other unused converter is set to 00h. The resistor ladder for the A/D converter is not considered.
Even when the VCUT bit in the AD0CON1 register is set to 0 (V_{REF} disconnected), I_{VREF} is supplied.

V_{CC} = 5 V

Timing Requirements (V_{CC} = 4.2 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.34 Multi-master I^2C-bus Interface

Symbol	Characteristic	Value				Unit
		Standard-mode		Fast-mode		
		Min.	Max.	Min.	Max.	
$t_{w(SCLH)}$	MSCL input high level pulse width	600		600		ns
$t_{w(SCLL)}$	MSCL input low level pulse width	600		600		ns
$t_{r(SCL)}$	MSCL input rise time		1000		300	ns
$t_{f(SCL)}$	MSCL input fall time		300		300	ns
$t_{r(SDA)}$	MSDA input rise time		1000		300	ns
$t_{f(SDA)}$	MSDA input fall time		300		300	ns
$t_{h(SDA-SCL)S}$	MSCL high level hold time after START condition/repeated START condition	(1)		2 × $t_{c(\phi IIC)}$ + 40		ns
$t_{su(SCL-SDA)P}$	MSCL high level setup time for repeated START condition/STOP condition	(1)		2 × $t_{c(\phi IIC)}$ + 40		ns
$t_{w(SDAH)P}$	MSDA high level pulse width after STOP condition	(1)		4 × $t_{c(\phi IIC)}$ + 40		ns
$t_{su(SDA-SCL)}$	MSDA input setup time	100		100		ns
$t_{h(SCL-SDA)}$	MSDA input hold time	0		0		ns

Note:

1. The value is calculated by the following formulas based on a value SSC by setting bits SSC4 to SSC0 in the I2CSSCR register:

   $t_{h(SDA-SCL)S}$ = SSC ÷ 2 × $t_{c(\phi IIC)}$ + 40 [ns]

   $t_{su(SCL-SDA)P}$ = (SSC ÷ 2 + 1) × $t_{c(\phi IIC)}$ + 40 [ns]

   $t_{w(SDAH)P}$ = (SSC + 1) × $t_{c(\phi IIC)}$ + 40 [ns]

V_{CC} = 5 V

Switching Characteristics (V_{CC} = 4.2 to 5.5 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.36 External Bus Timing (multiplexed bus)

Symbol	Characteristic	Measurement Condition	Value		Unit
			Min.	Max.	
$t_{su(S-ALE)}$	Chip-select setup time before ALE	Refer to Figure 5.6	(1)		ns
$t_{h(R-S)}$	Chip-select hold time after read		1.5 × $t_{c(Base)}$ - 15		ns
$t_{su(A-ALE)}$	Address setup time before ALE		(1)		ns
$t_{h(ALE-A)}$	Address hold time after ALE		0.5 × $t_{c(Base)}$ - 5		ns
$t_{h(R-A)}$	Address hold time after read		1.5 × $t_{c(Base)}$ - 15		ns
$t_{d(ALE-R)}$	ALE-read delay time		0.5 × $t_{c(Base)}$ - 5	0.5 × $t_{c(Base)}$ + 10	ns
$t_{w(ALE)}$	ALE pulse width		(1)		ns
$t_{dis(R-A)}$	Address disable time after read			8	ns
$t_{w(R)}$	Read pulse width		(1)		ns
$t_{h(W-S)}$	Chip-select hold time after write		1.5 × $t_{c(Base)}$ - 15		ns
$t_{h(W-A)}$	Address hold time after write		1.5 × $t_{c(Base)}$ - 15		ns
$t_{d(ALE-W)}$	ALE-write delay time		0.5 × $t_{c(Base)}$ - 5	0.5 × $t_{c(Base)}$ + 10	ns
$t_{w(W)}$	Write pulse width		(1)		ns
$t_{su(D-W)}$	Data setup time before write		(1)		ns
$t_{h(W-D)}$	Data hold time after write		0.5 × $t_{c(Base)}$		ns

Note:

1. The value is calculated using the formulas below based on the base clock cycles ($t_{c(Base)}$) and respective cycles of Tsu(A-R), Tw(R), Tsu(A-W), and Tw(W) set by registers EBC0 to EBC3. If the calculation results in a negative value, modify the value to be set. For details on how to set values, refer to the User's manual.

   $t_{su(S-ALE)}$ = $t_{su(A-ALE)}$ = $t_{w(ALE)}$ = (Tsu(A-R) - 0.5) × $t_{c(Base)}$ -15 [ns]

   $t_{w(R)}$ = Tw(R) × $t_{c(Base)}$ -10 [ns]

   $t_{w(W)}$ = $t_{su(D-W)}$ = Tw(W) × $t_{c(Base)}$ -10 [ns]

V_{CC} = 3.3 V

Table 5.43 Electrical Characteristics (3/3)
(V_{CC} = 3.0 to 3.6 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Symbol	Characteristic	Measurement Condition		Value			Unit
				Min.	Typ.	Max.	
I_{CC}	Power supply current	In single-chip mode, output pins are left open and others are connected to V_{SS} XIN-XOUT Drive strength: low XCIN-XCOUT Drive strength: low	$f_{(CPU)}$ = 64 MHz, $f_{(BCLK)}$ = 32 MHz, $f_{(XIN)}$ = 8 MHz, Active: XIN, PLL, Stopped: XCIN, OCO		40	55	mA
			$f_{(CPU)}$ = 50 MHz, $f_{(BCLK)}$ = 25 MHz, $f_{(XIN)}$ = 8 MHz, Active: XIN, PLL, Stopped: XCIN, OCO		32	45	mA
			$f_{(CPU)}$ = $f_{SO(PLL)}$/24 MHz, Active: PLL (self-oscillation), Stopped: XIN, XCIN, OCO		9		mA
			$f_{(CPU)}$ = $f_{(BCLK)}$ = $f_{(XIN)}$/256 MHz, $f_{(XIN)}$ = 8 MHz, Active: XIN, Stopped: PLL, XCIN, OCO		670		µA
			$f_{(CPU)}$ = $f_{(BCLK)}$ = 32.768 kHz, Active: XCIN, Stopped: XIN, PLL, OCO, Main regulator: shutdown		180		µA
			$f_{(CPU)}$ = $f_{(BCLK)}$ = $f_{(OCO)}$/4 kHz, Active: OCO, Stopped: XIN, PLL, XCIN, Main regulator: shutdown		190		µA
			$f_{(CPU)}$ = $f_{(BCLK)}$ = $f_{(XIN)}$/256 MHz, $f_{(XIN)}$ = 8 MHz, Active: XIN, Stopped: PLL, XCIN, OCO, T_a = 25°C, Wait mode		500	900	µA
			$f_{(CPU)}$ = $f_{(BCLK)}$ = 32.768 kHz, Active: XCIN, Stopped: XIN, PLL, OCO, Main regulator: shutdown, T_a = 25°C, Wait mode		8	140	µA
			$f_{(CPU)}$ = $f_{(BCLK)}$ = $f_{(OCO)}$/4 kHz, Active: OCO, Stopped: XIN, PLL, XCIN, Main regulator: shutdown, T_a = 25°C, Wait mode		10	150	µA
			Stopped: all clocks, Main regulator: shutdown, T_a = 25°C		5	70	µA

V_{CC} = 3.3 V

Timing Requirements (V_{CC} = 3.0 to 3.6 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.53 Timer B Input (counting input in event counter mode)

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiIN input clock cycle time (one edge counting)	200		ns
$t_{w(TBH)}$	TBiIN input high level pulse width (one edge counting)	80		ns
$t_{w(TBL)}$	TBiIN input low level pulse width (one edge counting)	80		ns
$t_{c(TB)}$	TBiIN input clock cycle time (both edges counting)	200		ns
$t_{w(TBH)}$	TBiIN input high level pulse width (both edges counting)	80		ns
$t_{w(TBL)}$	TBiIN input low level pulse width (both edges counting)	80		ns

Table 5.54 Timer B Input (pulse period measure mode)

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiIN input clock cycle time	400		ns
$t_{w(TBH)}$	TBiIN input high level pulse width	180		ns
$t_{w(TBL)}$	TBiIN input low level pulse width	180		ns

Table 5.55 Timer B Input (pulse-width measure mode)

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiIN input clock cycle time	400		ns
$t_{w(TBH)}$	TBiIN input high level pulse width	180		ns
$t_{w(TBL)}$	TBiIN input low level pulse width	180		ns

V_{CC} = 3.3 V

Timing Requirements (V_{CC} = 3.0 to 3.6 V, V_{SS} = 0 V, and T_a = T_{opr}, unless otherwise noted)

Table 5.56 Serial Interface

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi input clock cycle time	200		ns
$t_{w(CKH)}$	CLKi input high level pulse width	80		ns
$t_{w(CKL)}$	CLKi input low level pulse width	80		ns
$t_{su(D-C)}$	RXDi input setup time	80		ns
$t_{h(C-D)}$	RXDi input hold time	90		ns

Table 5.57 A/D Trigger Input

Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{w(ADH)}$	$\overline{ADTRG}$ input high level pulse width Hardware trigger input high level pulse width	$\frac{3}{\phi_{AD}}$		ns
$t_{w(ADL)}$	$\overline{ADTRG}$ input low level pulse width Hardware trigger input high level pulse width	125		ns

Table 5.58 External Interrupt $\overline{INTi}$ Input

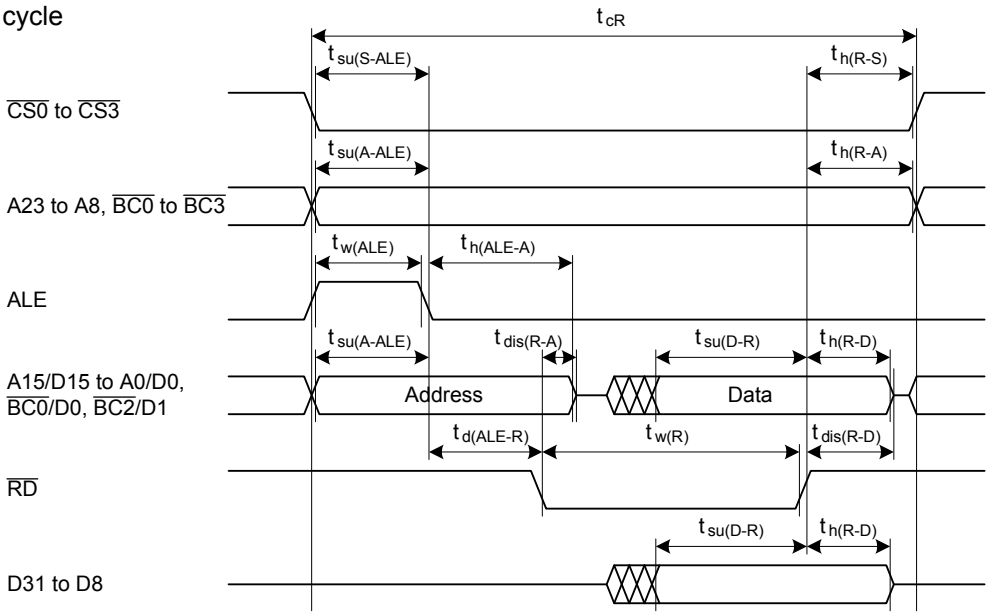
Symbol	Characteristic		Value		Unit
			Min.	Max.	
$t_{w(INH)}$	$\overline{INTi}$ input high level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{c(CPU)}$ + 200		ns
$t_{w(INL)}$	$\overline{INTi}$ input low level pulse width	Edge sensitive	250		ns
		Level sensitive	$t_{c(CPU)}$ + 200		ns

Table 5.59 Intelligent I/O

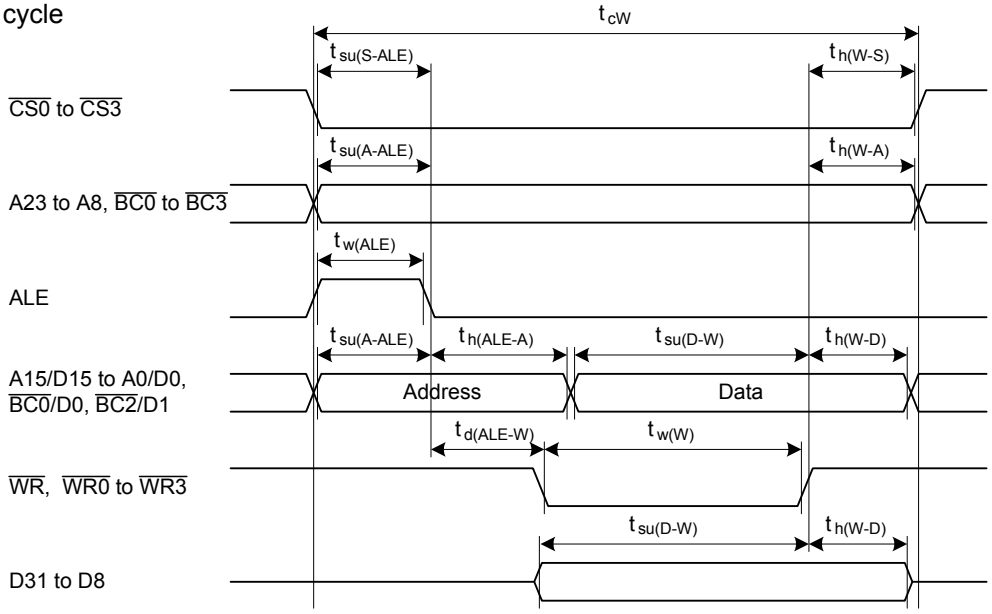
Symbol	Characteristic	Value		Unit
		Min.	Max.	
$t_{c(ISCLK2)}$	ISCLK2 input clock cycle time	600		ns
$t_{w(ISCLK2H)}$	ISCLK2 input high level pulse width	270		ns
$t_{w(ISCLK2L)}$	ISCLK2 input low level pulse width	270		ns
$t_{su(RXD-ISCLK2)}$	ISRXD2 input setup time	150		ns
$t_{h(ISCLK2-RXD)}$	ISRXD2 input hold time	100		ns

External bus timing (multiplexed bus)

Read cycle



Write cycle



Measurement conditions

Item		V_{CC} = 4.2 to 5.5 V	V_{CC} = 3.0 to 3.6 V
Criterion for input voltage	V_{IH}	2.5 V	1.5 V
	V_{IL}	0.8 V	0.5 V
Criterion for output voltage	V_{OH}	2.0 V	2.4 V
	V_{OL}	0.8 V	0.5 V

Figure 5.9 External Bus Timing for Multiplexed Bus

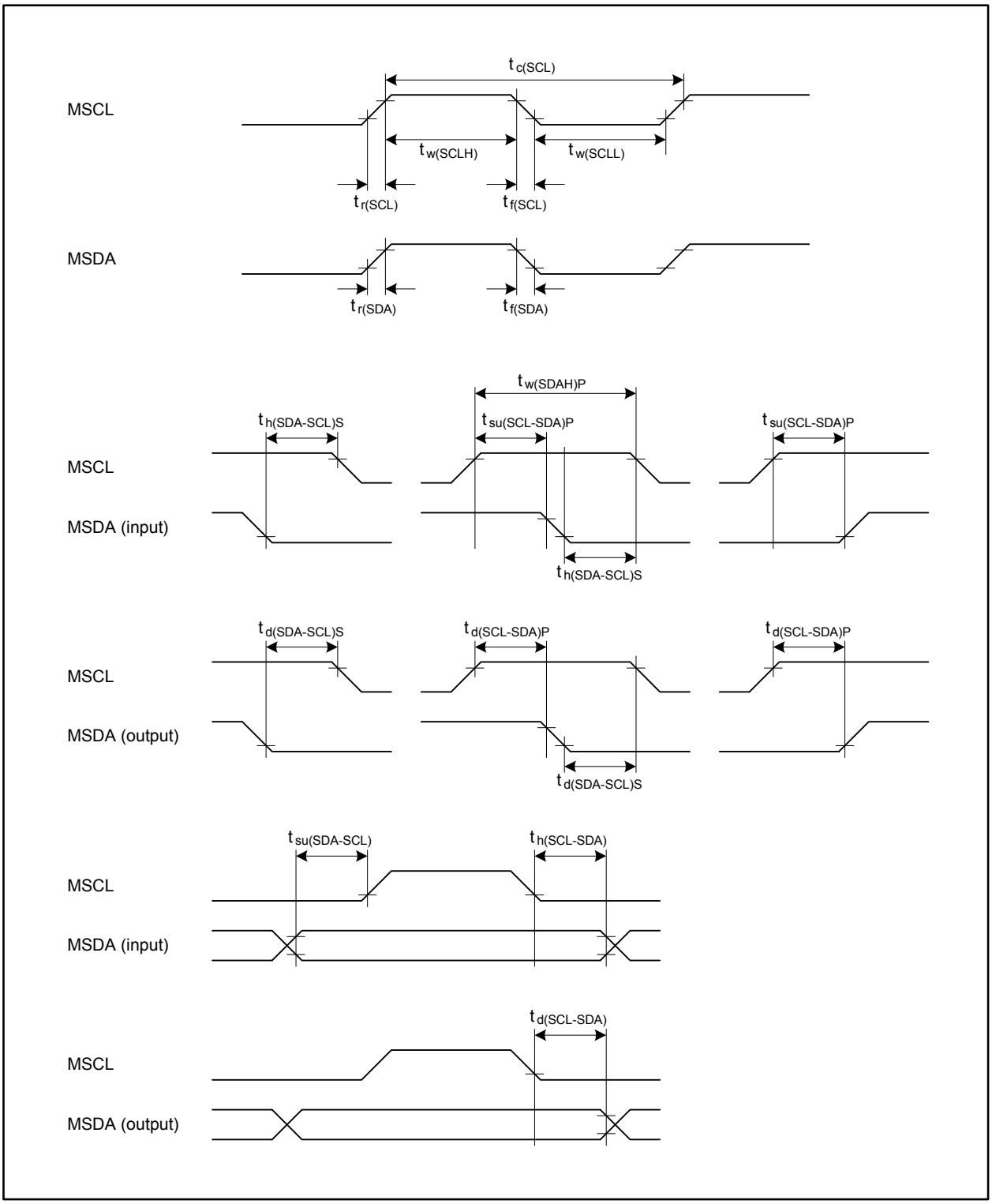


Figure 5.11 Timing of Multi-master I²C-bus Interface

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